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PATENT APPLICATION

IN THE U.S. PATENT AND TRADEMARK OFFICE

February 16, 2010

Applicants: Hironori KOBAYASHI et al

For: RESIN COMPOSITION

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P.O. Box 1450
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

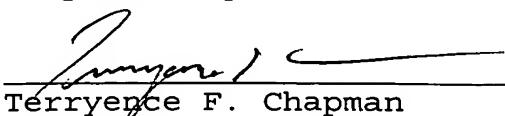
Sir:

In compliance with the provisions of Rules 1.97(e)(1) and 1.98, enclosed herewith is a copy of a Japanese Office Action, Form PTO-1449 and the references cited thereon. The relevance of these references is explained on the enclosed sheet. Accordingly, further comment at this point in time should not be necessary.

I hereby certify that each item of information contained in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.

Further consideration is respectfully solicited.

Respectfully submitted,



Terryence F. Chapman

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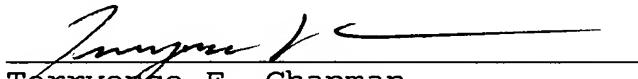
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Encl: Copy of Japanese Office Action dated January 29, 2010
Copy of Concise Explanation of Relevance
Form PTO-1449 and references cited thereon
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I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on February 16, 2010.



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